

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Patent Application of:
Taichi Inoue et al.

Application No.: National Phase of
PCT/JP2004/019233

Confirmation No.: N/A

Filed: Concurrently Herewith

Art Unit: N/A

For: **METHOD AND APPARATUS FOR
MANUFACTURING IC CHIP PACKAGED
DEVICE**

Examiner: Not Yet Assigned

FIRST PRELIMINARY AMENDMENT

MS Amendment
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Dear Sir:

INTRODUCTORY COMMENTS

Prior to examination on the merits, please amend the above-identified U.S. patent application as follows:

Amendments to the Specification begin on page 2 of this paper.

Remarks/Arguments begin on page 3 of this paper.